

Application No.: 10/784,860

Case No.: 58065US008

Amendments to the Claims:

The following Listing of Claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims

1. (Currently Amended) An article comprising:
a flexure assembly of a hard disk drive comprising a metal substrate and a dielectric film attached to said metal substrate, said dielectric film comprising a polymer selected from the group consisting of polyimide copolymers including carboxylic ester structural units in the polymeric backbone and polycarbonates, wherein said dielectric film has been etched to a controlled thickness of greater than 0 and less than about 20 μm from an original thickness of about 25 μm or greater.
2. (Cancelled)
3. (Original) An article according to claim 1 wherein the dielectric film is attached to the metal substrate by an adhesive layer.
4. (Cancelled)
5. (Currently Amended) An article according to claim 1 wherein the dielectric film has been etched to a thickness of greater than 0 and less than about 10 μm .
6. (Original) An article according to claim 1 further comprising a patterned conductive layer on the dielectric layer.
7. (Original) An article according to claim 1 including at least one unsupported cantilevered lead.
8. (Cancelled)
9. (Cancelled)
10. (Cancelled)
11. (Cancelled)
12. (Cancelled)
13. (Cancelled)

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- 14. (Cancelled)
- 15. (Cancelled)
- 16. (Cancelled)
- 17. (Cancelled)